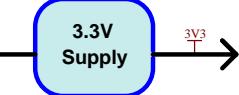
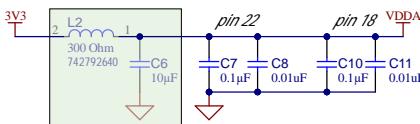
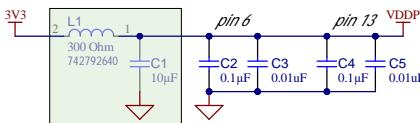


Input Power
(i.e. 12V)

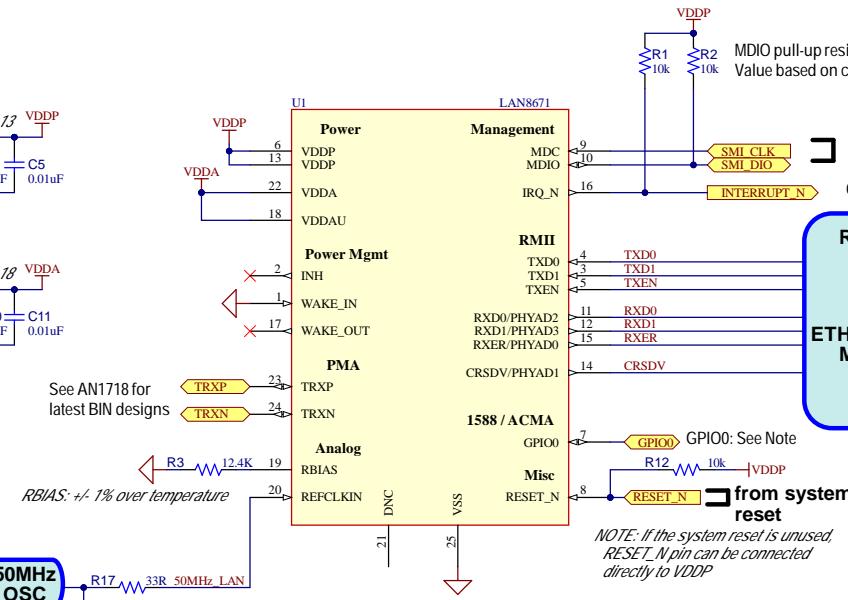


LAYOUT NOTE: Place one 0.01uF and one 0.1uF at each power pin. The 0.01uF must be closest to the pin.



Ferrite beads are optional. If used, a bulk capacitor is recommended on the device side of the ferrite bead to dampen potential oscillation.

LAN8671 RMII Application - No Wake/Sleep



LAYOUT NOTE: 50MHz_LAN and 50MHz_MAC
PCB traces should be length matched.



GPIO0: Configurable as ACMA, TXPI, RXPI or RXTUPI
(if unused, leave unconnected)

VDDP

R1 10k

R2 >10k

MDIO pull-up resistor:
Value based on capacitive bus loading. For light loading, 10k Ohms is a good starting value.

Serial Management Interface (SMI)

OPTIONAL: IRQ_N: If used, a pull-up resistor is required

Hardware Configuration Straps:

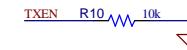
Values are latched upon POR RESET_N negated.

EXTERNAL RESISTORS (REQUIRED)

10k Ohm typical Strap resistors.

Strap resistor value is dependent on the Ethernet MAC internal resistor values.

Strap resistors must be able to override the Ethernet MAC internal pull-up or down resistor to set a logic low or high.



NOTE: When the MAC sublayer is in reset or unconfigured, the TXEN output pin may become high impedance and floating. A pull-down can be added to prevent false TXEN assertions and accidental transmissions.